



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

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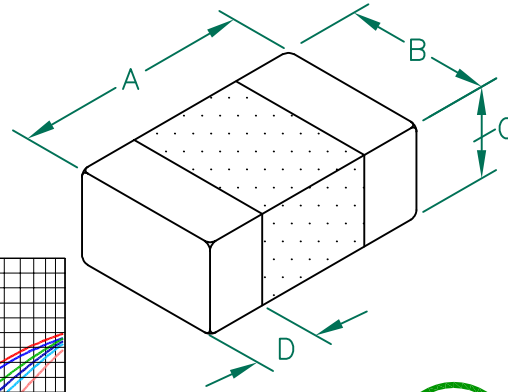


MI0805K110R-10

**UNCONTROLLED
DOCUMENT**

PHYSICAL DIMENSIONS:

A	2.00 [.079]	+ 0.20 [.008]
B	1.25 [.049]	+ 0.20 [.008]
C	0.90 [.035]	+ 0.20 [.008]
D	0.51 [.020]	+ 0.25 [.010]

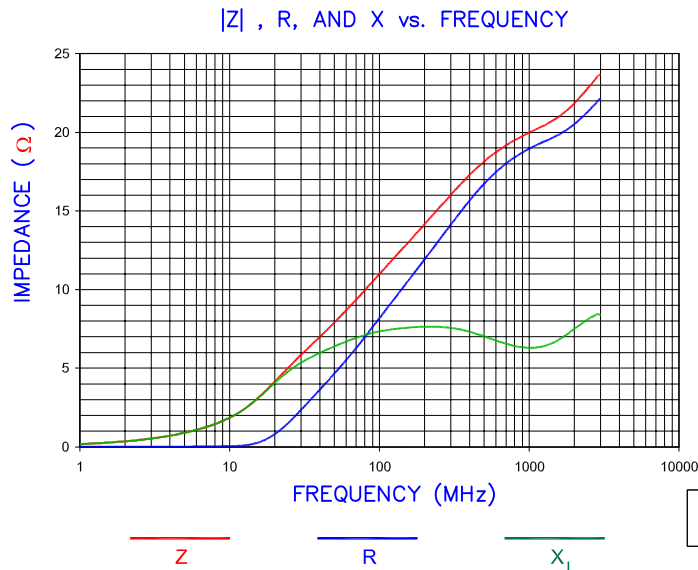
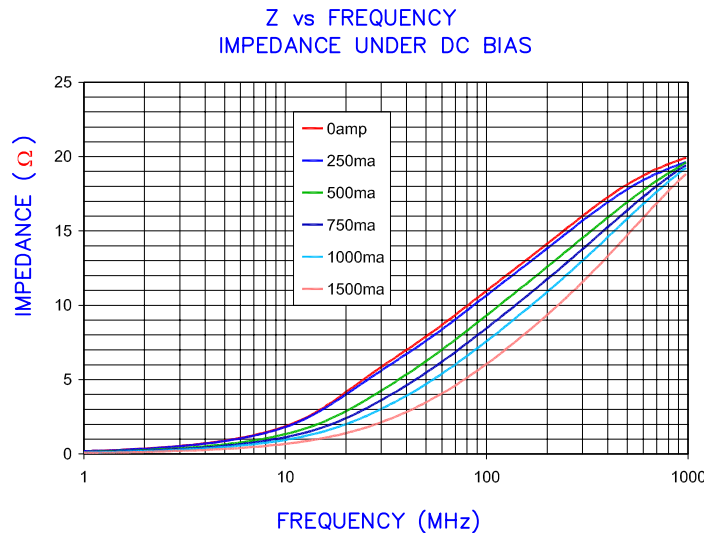


ELECTRICAL CHARACTERISTICS:

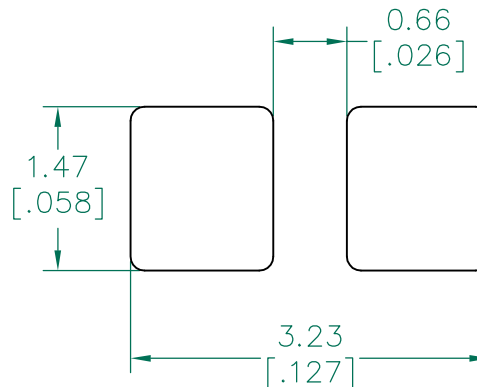
Z @ 100MHz (Ω)	DCR (Ω)	Rated Current
Nominal	11	
Minimum	8	
Maximum	14	0.06 1500 mA

NOTES: UNLESS OTHERWISE SPECIFIED

1. TAPED AND REELED per CURRENT EIA SPECIFICATIONS 7" REELS, 4000 PCS/REEL, PAPER TAPE.
2. TERMINATION FINISH IS 100% TIN.
3. COMPONENTS SHOULD BE ADEQUATELY PREHEATED BEFORE SOLDERING.
4. OPERATING TEMP. RANGE: $-40^{\circ}\text{C} \sim +125^{\circ}\text{C}$. (INCLUDING SELF-HEATING)

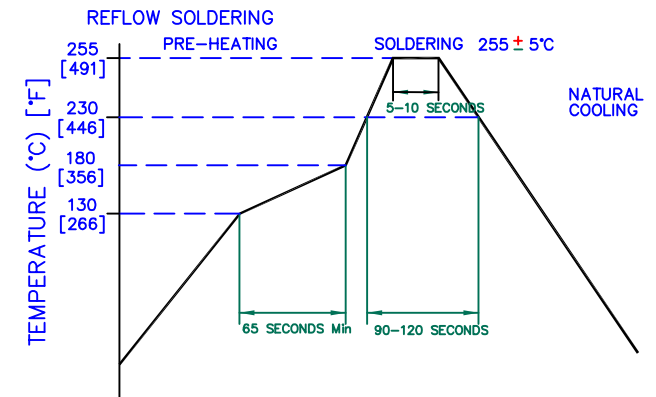


LAND PATTERNS FOR REFLOW SOLDERING



(For wave soldering, add 0.762 [.030] to this dimension)

RECOMMENDED SOLDERING CONDITIONS



DIMENSIONS ARE IN mm [INCHES].

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PROJECT/PART NUMBER:				REV	PART TYPE:
MI0805K110R-10				E	CO-FIRE
DATE: 04/05/04				SCALE: -	SHEET: 2 of 2
CAD # MI0805K110R-10-E				TOOL # -	
DATE				INT	
DESCRIPTION					
REV					
E	ADD OPERATING TEMPERATURE UPDATE LAIRD LOGO AND REFLOW CURVE			08/05/13	QU
D	CHANGE TO PAPER TAPE			03/04/10	JUN
C	UPDATE COMPANY LOGO			08/06/08	JRK
B	ADD ROHS & UPDATE COMPANY LOGO			08/28/07	JRK
A	ORIGINAL DRAFT			04/05/04	TMB